

SANYO Semiconductors DATA SHEET

LA72700V — US MTS (Multi Channel Television Sound) Decoder

Overview

LA72700V is a US MTS (Multi Channel Television Sound) decoder.

Features

- With SIF circuit, STEREO channel separation is alignment-free.
- Built-in filters are adjustment free.
- SAP output level is selectable 2 levels.
- Included control function for STEREO and SAP detection sensitivity.

Functions

- SIF FM-Demodulator.
- STEREO decoder.
- ALC function is included.
- dbx Noise Reduction system.
- SAP demodulator.
- STEREO detection.
- SAP detection.

Specifications

Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum power supply voltage	V _{CC} max		9.6	V
Allowable power dissipation	Pd max	Ta≤70°C *	810	mW
Operating temperature	Topr		-10 to +70	°C
Storage temperature	Tstg		-55 to +150	°C

^{*} ON board (114.3 \times 76.1 \times 1.6 mm Glass Epoxy resin board)

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Operating Conditions at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Recommended operating voltage	VCC		9.0	٧
Operating voltage range	V _{CC} op		8.5 to 9.5	V

Electrical Characteristics at Ta = 25°C, $V_{CC} = 9.0V$

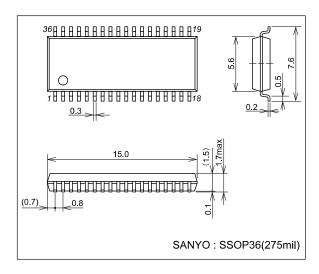
Parameter	Symbol	Conditions		Ratings		Unit
Parameter	Symbol	Conditions	min	typ	max	Unit
Current dissipation	lcc	No signal Inflow current at pin 31	50	60	70	mA
		* Default condition				
SIF input level	VILIM	fc = 4.5MHz	(80)	(90)	(100)	dΒμV
(Reference)		Deviation				
		MONO (300Hz, Mod = 100%, Pre-emphasis ON) →				
		±25kHz				
Base band input level	VILIMB	100% Modulation				
(Reference)		MONO(L+R): 530mVp-p (300Hz, Pre-emphasis ON)				
		SUB(L-R): 380mVp-p (300Hz, dbx-NR ON), Pilot: 1	10mVp-p			
		SAP: 300mVp-p (300Hz, dbx-NR ON)				
MONO output level	VOMON	Input: fm = 1kHz, 100% Mod, MONORAL	-7.0	-6.0	-5.0	dBV
		Measure OUT (L), OUT (R)				
MONO distortion	THDMON	Input: fm = 1kHz, 100% Mod, MONORAL		0.15	0.6	%
		Measure OUT (L), OUT (R)				
MONO frequency characteristics	FCM1	Input: fm = 8kHz, 30% Mod, MONORAL	-2	0	2	dB
		Measure OUT(L), OUT(R),				
		Ratio from fm = 1kHz level.				
MONO S/N ratio	SNM	S = VOMON, N = 0% Mod	55	65		dB
		Measure OUT (L), OUT (R)				
		With 15kHz LPF, JIS-A				
STEREO output level	VOST	Input: fm = 1kHz, 100% Mod, STEREO	-7.0	-6.0	-5.0	dBV
		Measure OUT (L), OUT(R)				
STEREO distortion	THDS	Input: fm = 1kHz, 100% Mod, STEREO		1.0	2.5	%
		Measure OUT (L), OUT (R)				
STEREO frequency	FCS1	fm = 8kHz, 30% Mod, STEREO	-3	0	3	dB
characteristics		Measure OUT (L), OUT (R),				
		Ratio from fm = 1kHz level.				
STEREO S/N ratio	SNS	S = VOST, N = 0% Mod	50	60		dB
		Measure OUT (L), OUT (R)				
		With 15kHz LPF, JIS-A				
STEREO separation 1	STSE1	f = 300Hz (R/L), 30% Mod	20	25		dB
		Measure ratio OUT (L) with OUT (R)				
STEREO separation 2	STSE2	f = 3kHz (R/L), 30% Mod	20	25		dB
		Measure ratio OUT (L) with OUT (R)				
STEREO Detection level-1	VINSD1	Except Stereo Detection → Stereo Detection	52	57	62	%
		Measure PILOT level, at STERO det.				
STEREO Detection level-2	VINSD2	Except Stereo Detection → Stereo Detection	62	67	72	%
		* Insert Resistor pin 14 to GND (ex. 51k Ω)				
		Measure PILOT level, at STERO det.				

Parameter	Symbol	Conditions		Unit		
i arameter	Symbol	Conditions	min	typ	max	Offic
STEREO detection hysteresis	HYST	Input Mod. Difference at Stereo /Except Stereo Det. * at default condition	10	15	25	%
SAP output level-1	VOSA	Fm = 1kHz, 100% Mod, SAP Measure OUT (L), OUT * at bit6 = 0	-7.5	-6.5	-5.5	dBV
SAP output level-2	VOSA2	Fm = 1kHz, 100% Mod, SAP Measure OUT (L), OUT * at bit6 = 1	-5.5	-4.5	-3.5	dBV
SAP distortion	THDSA	Fm = 1kHz, 100% Mod, SAP Measure OUT (L), OUT		1.5	3.5	%
SAP S/N ratio	SNSA	S = VOSA, N = 0% Mod, Measure OUT (L), OUT (R) With 15kHz LPF, JIS-A	55	65		dB
SAP detection level-1	VINSA1	Measure SAP carrier level, when SAP det * Default condition	13	18	23	%
SAP detection level-2 (Reference)	VINSA2	Measure SAP carrier level, when SAP det * pin15 to GND (ex 33kΩ)	(5)	(10)	(15)	%
SAP detection level-3 (Reference)	VINSA3	Measure SAP carrier level, when SAP det * pin15 to GND (ex 8.2kΩ)	(20)	(25)	(30)	%
SAP detection hysteresis	HYSA	Input Mod. Difference at SAP/Except SAP Det. * at default condition	2	5	10	%
MODE output MONO	MODMO	Input = MONO: f = 1kHz, 0% Mod Measure pin32	0.7	1	1.3	V
MODE output SAP	MODSA	Input = SAP: Carrier Measure pin32	1.7	2	2.3	V
MODE output STEREO	MODST	Input = STEREO: Pilot Measure pin32	2.7	3	3.3	V
MODE output ST + SAP	MODSS	Input = STEREO: Pilot, SAP: Carrier Measure pin32	3.5	3.8	4.2	V
Distortion	THDALC	MONO 1kHz Mod 100% * ALC on Measure OUT (L), OUT (R)		0.3	0.5	%

^{*} Normally measurement condition is Input = SIF mode (-90dB μ V), ALC = OFF

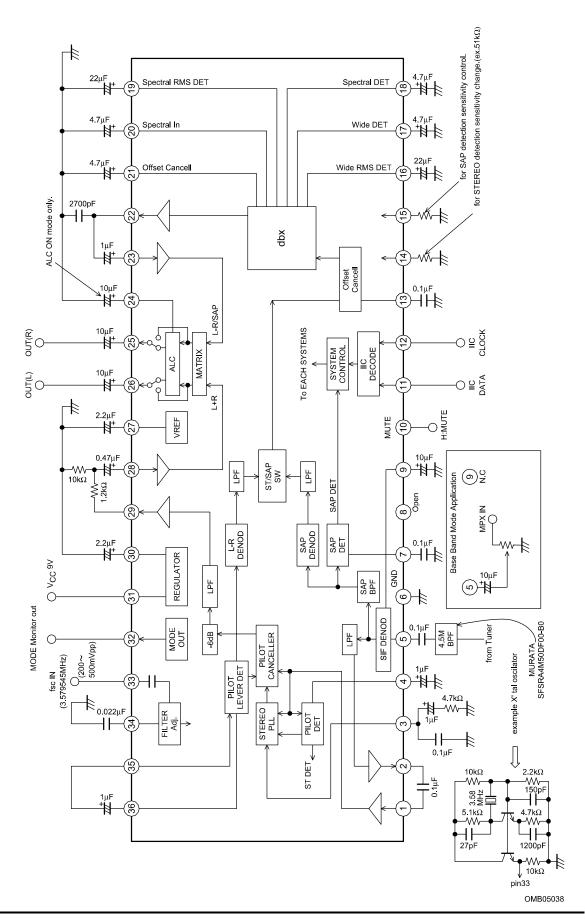
Package Dimensions

unit : mm 3247B



^{* &}quot; Reference " Items are reference levels, their specs are no-guarantee.

Block Diagram and Application Circuit Example



00p-1 (Normally use: group-1 only)

	D8	D7	D6	D5	D4	D3	D2	D1	Condition
*							0	0	Stereo
							0	1	SAP
							1	0	Both
							1	1	Prohibit
*						0			Normal (Auto det)
						1			Forced Mono
*					0				Normal (MUTE off)
					1				MUTE
*				0					ALC off (Through)
				1					ALC on
*			0						SAP LEVEL-1
			1						SAP LEVEL-2
*		0							SIF mode
		1							Base Band mode
*	0								Fix
	1								Prohibit (TEST MODE)

^{*:} Initial condition

Read out data

D8	D7	D6	D5	D4	D3	D2	D1	Condition
		0	0	0	0	0	0	Fixed
	0							Normal
	1							SAP det
0								Normal
1								Stereo det

Test mode condition

When STOP condition transform at Grp-1 data-end, controlled NORMAL mode. Grp-2(Only test condition: Normally, this data is no-need)

D8	D7	D6	D5	D4	D3	D2	D1	Condition/Monitor position
0	0	0	0	0	0	0	0	Normal (Usually, Fixed)
0	0	0	0	0	0	0	1	TEST-1 SIF output
0	0	0	0	0	0	1	0	TEST-2 SAP BPF
0	0	0	0	0	0	1	1	TEST-3 SAP VCO
0	0	0	0	0	1	0	0	TEST-4 ST VCO
0	0	0	0	0	1	0	1	TEST-5 ADJ VCO
0	0	0	0	0	1	1	0	TEST-6 dbx input
0	0	0	0	0	1	1	1	TEST-7 L-R Demod output
0	0	0	0	1	0	0	0	TEST-8 Pilot cancel
0	0	0	0	1	0	0	1	TEST-9 dbx 2.19k LPF
0	0	0	0	1	0	1	0	TEST-10 dbx 408 LPF
0	0	0	0	1	0	1	1	TEST-11 dbx DET 10k LPF
0	0	0	0	1	1	0	0	TEST-12 dbx SPEC 7.6k LPF
0	0	0	0	1	1	0	1	TEST-13 dbx SPEC output
0	0	0	0	1	1	1	0	TEST-14 (No operation)
0	0	0	0	1	1	1	1	TEST-15 (No operation)

Pin Functions

	unctions			
No.	Pin function	DC voltage	Input/output form	Reference
INO.	1 III Idiletion	AC level	inpul/output form	Kalefalle
1	PC_DC_IN	DC: 3.8V AC: 2.4Vp-p	Vcc Vcc	AC coupling (Input)
2	PC_DCOUT	DC: 3.8V AC: 2.4Vp-p	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	AC coupling (Output)
3	PCSTFILT	DC: 3.8V	VCC 40kΩ 40kΩ 160kΩ 3 0MP05006	Stereo VCO PLL filter
4	PCPLDET	DC: 3.8V	VCC 40kΩ 160kΩ 40kΩ 160kΩ 0MP05007	Pilot level detect
5	PISIF	DC: 3.7V	5kΩ 500Ω 1kΩ OMP05008	Signal input

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		DC voltage		
No.	Pin function	AC level	Input/output form	Reference
6	GND			
	CSAPDET	DC: 2.8V	_	SAP carrier level detect
		50.20	OMD020009	
8	NC			No connect
9	PC FIL	DC: 2.9V	_	SIF offset cancel
10	MUTE	DC: 0V	OMP050111	MUTE = 5V
11	SDA	5V	11) 1kΩ OMP05012	Serial data input
12	SCL		1	Serial clock input
		5V	12 W 1kΩ 1kΩ OMP05013	

a	c	11	
Continued	from	preceding	page.

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No.	Pin function	DC voltage	Input/output form	Reference
		AC level	pss osipat ioiiii	
13	PC DBXIN	DC: 2.5V	450kΩ W 200Ω OMP05014	Offset cancel filter
14	PSTSENS	DC: 3.1V	—————————————————————————————————————	Stereo det sensitivity change
			1kΩ W (4) OMP05015	OPEN = default Insert resistor(30k or over) = Low sensitivity
15	PSAPSENS	DC: 3.1V		SAP detect sensitivity control OPEN = default
			1kΩ GYZ TIS OMP05016	controlled by insert resistor * see electrical reference
16	PCTNWID	DC: 4.0V	50000	dbx RMS detect(wide band)
			111 (16) OMP05017	
17	PCDETWID	DC: 3.8V	5kΩ 17 OMP05018	dbx wide detect

Continued	d from preceding pag	ge.		
No.	Pin function	DC voltage	Input/output form	Reference
		AC level	inpurouput ioiiii	
18	PCTIMSPE	DC: 3.8V	18 5κΩ OMP05019	dbx spectral detect
19	PCDETSPE	DC: 3.8V		dbx RMS detect (Spectral band)
			19 OMP05020	
20	PCSPECIN	DC: 3.8V	5kΩ 20 OMP05021	dbx main signal V/I convert filter
21	PCDOSPE	DC: 3.8V	1 -	Offset cancel filter
		AC: 220mVp-p	OMP05022	
22	PCDBXOUT	DC: 3.8V	Vcc	AC coupling (Output)
23	PCDBX_IN	AC: 220mVp-p		AC coupling (Input)
23	PODBA_IN		OMP05023	AC coupling (input)

Continued	I from preceding pag	e.				
No.	Pin function	DC voltage	In model out the other control	Deference		
INO.	Pin function	AC level	Input/output form	Reference		
24	PCALCFIL	DC: 0.6V	2kΩ 150Ω OMP05024	ALC filter * When ALC function no-use, this terminal is open.		
25	PORCH	DC: 3.8V AC: 1.4mVp-p	200Ω 200Ω OMP05025	Line out R		
26	POLCH	DC: 3.8V AC: 1.4mVp-p	200Ω 200Ω OMP05026	Line out L		
27	PCREG	DC: 3.8V	60ka 28ka 55ka 00000000000000000000000000000000	Reference Voltage		

Continued	l from preceding pag	ge.			
No.	Pin function	DC voltage	Input/output form	Reference	
		AC level			
28	PMAIN_IN	DC: 3.5V	Vcc	AC coupling (Input)	
		AC: 220mVp-p			
			* 1		
29	PMAINOUT	DC: 3.8V	- Μ - Μ - ΚΩ - Γ - Γ - Γ - Γ - Γ - Γ - Γ - Γ - Γ -	AC coupling (Output)	
29	I WAINOUT	AC: 220mVp-p		Ac coupling (Output)	
			'1		
			OMP05028		
30	PCREG76	DC: 1.2V	+	Regulator	
			30kp		
			₩ 8kΩ		
			W 1κΩ		
			25kg		
			<i>#</i> 39		
			OMP05029		
31	Vcc				
32	POLED	DC*		Mode out	
		* See Mode	_	MONO = 0.9V	
		table		SAP = 2.0V	
			(32)	STEREO = 3.0V STEREO+SAP = 3.8V	
			32 500Ω 5kΩ	31EREU+3AY = 3.8V	
			<i>#</i>		
			OMP05030		
33	PICLKFSC	DC: 0V	30pF	Fsc input	
		AC* * 200mVp-p	33 W	3.579545MHz, 200mVp-p	
		Recommend	<u> </u>		
			10κΩ		
			7/// OMB05004		
			/// OMP05031		

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No.	Pin function	DC voltage	Input/output form	Reference	
140.	1 III Idriction	AC level	input output form		
34	PCDJFIL	DC: 2.5V	200Ω 1kΩ 34 OMP05032	Filter adjustment signal detect	
35	PCPLC	DC: 6.3V	VCC 1κΩ 1κΩ W-35 W-	Pilot canceller reference-1	
36	PCPLC2	DC: 6.3V	20kΩ 1kΩ OMP05033	Pilot canceller reference-2	

Serial Control (I²C)

(1) Data Transfer Manual

This LSI adopts control method (I²C -BUS) with serial data, and controlled by two terminals which called SCL (serial clock) and SDA (serial data). At first, set up *1 the condition of starting data transfer, and after that, input 8 bit data to SDA terminal with synchronized SCL terminal clock. The order of transferring is first, MSB (the Most Scale of Bit), and save the order. The 9th bit takes ACK (Acknowledge) period, during SCL terminal takes 'H', this LSI pull down the SDA terminal. After transferred the necessary data, two terminals lead to set up and of *2 data transfer stop condition, thus the transfer comes to close.

(2) Transfer Data Format

After transfer start condition, transfers slave address (1000000*) to SDA terminal, control data, then, stop condition (See figure 1).

Slave address is made up of 7bits, *3 8th bit shows the direction of transferring data, if it is "L", takes write mode (As this LSI side, this is input operation mode), and in case of 'H', reading mode (As this LSI side, this is output operation mode).

Data works with all of bit, transfer the stop condition before stop 8bit transfer, and to stop transfer, it will be canceled the transfer dates.

Fig.1 DATA STRUCTURE "WRITE" mode

START Condition	Slave Address	R/W ACK	Control data	ACK	STOP condition			
Fig.2 DATA STRUCTURE " READ " mode								

START condition	Slave Address	R/W ACK	Internal Data*	ACK	STOP condition

^{*} Output 5bits data as follows;

bit8 is result of STERO DET (H: STEREO)

bit7 is result of SAP DET (H: SAP)

bit6 to bit1 are fixed to "L"

^{*1} Defined by SCL rise down SDA during 'H' period.

^{*2} Defined by SCL rise up SDA during 'H' period.

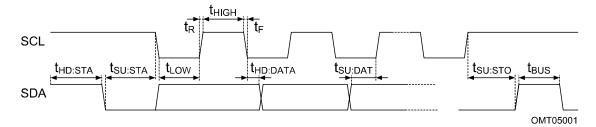
^{*3} It is called R/W bit.

(3) Initialize

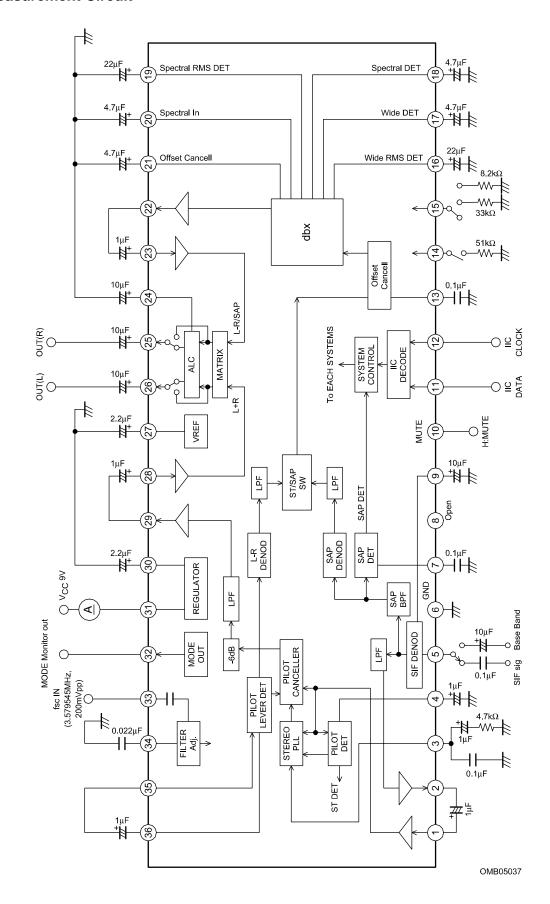
This LSI is initialized for circuit protection. Initial condition is "0 (all bits)".

Parameter	Symbol	Min	Max	Unit
LOW level input voltage	V _{IL}	-0.5	1.5	V
HIGH level input voltage	VIIH	3.0	5.5	V
LOW level output current	l _{OL}		3.0	mA
SCL clock frequency	fSCL	0	100	kHz
Set-up time for a repeated START condition	^t SU: STA	4.7		μs
Hold time START condition. After this period, the first clock pulse is generated	tHD: STA	4.0		μs
LOW period of the SCL clock	t _{LOW}	4.7		μs
Rise time of both SDA and SDL signals	t _R	0	1.0	μs
HIGH period of the SCL clock	tHIGH	4.0		μs
Fall time of both SDA and SDL signals	t _F	0	1.0	μs
Data hold time	tHD: DAT	0		μs
Data set-up time	^t SU: DAT	250		ns
Set-up time for STOP condition	tsu: sto	4.0		μs
BUS free time between a STOP and START condition	^t BUF	4.7		μs

Timing Chart



Measurement Circuit



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